

IEEE Standard for Low-Rate Wireless Networks

Amendment 7: Defining Enhancements to the Smart Utility Network (SUN) Physical Layers (PHYs) Supporting up to 2.4 Mb/s Data Rates

IEEE Computer Society

Developed by the
LAN/MAN Standards Committee

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(Amendment to IEEE Std 802.15.4™-2015
as amended by IEEE Std 802.15.4n™-2016,
IEEE Std 802.15.4q™-2016, IEEE Std 802.15.4u™-2016,
IEEE Std 802.15.4t™-2017, IEEE Std 802.15.4v™-2017,
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Approved 21 March 2019

IEEE-SA Standards Board

Abstract: Enhancements to the IEEE 802.15.4™ smart utility network (SUN) orthogonal frequency division multiplexing (OFDM) physical layers (PHYs) that enable support for data rates up to 2.4 Mb/s are defined by this amendment to IEEE Std 802.15.4™-2015. This amendment also defines additional channel plans, as needed, to support emerging applications.

Keywords: amendment, IEEE 802.15.4™, IEEE 802.15.4x™, low data rate, low power, wireless personal area network, WPAN

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Introduction

This introduction is not part of IEEE Std 802.15.4x-2019, IEEE Standard for Low-Rate Wireless Networks—Amendment 7: Defining Enhancements to the Smart Utility Network (SUN) Physical Layers (PHYs) Supporting up to 2.4 Mb/s Data Rates.

This amendment defines enhancements to the IEEE 802.15.4 smart utility network (SUN) orthogonal frequency division multiplexing (OFDM) physical layers (PHYs) that enable support for data rates up to 2.4 Mb/s. This amendment also defines additional channel plans, as needed, to support emerging applications.

Building upon the numerous successful deployments of the IEEE 802.15.4 SUN PHY technology in field area networking (FAN) and the rapid growth in applications, such as the Internet of Things (IoT), Smart Grid, Smart Cities, and others, these SUN PHY enhancements are needed to support higher data rates along with enhancements for longer range utilizing existing hardware deployments based upon the IEEE 802.15.4 SUN PHYs. As an example, these enhancements enable broader electric system distribution automation and reduce the amount of equipment needed for deployment in Smart Grid systems. This example is but one of many application areas where FAN enhancements can have a substantial beneficial impact.

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Amendment 7: Defining Enhancements to the Smart Utility Network (SUN) Physical Layers (PHYs) Supporting up to 2.4 Mb/s Data Rates

(This amendment is based on IEEE Std 802.15.4™-2015 as amended by IEEE Std 802.15.4n™-2016, IEEE Std 802.15.4q™-2016, IEEE Std 802.15.4u™-2016, IEEE Std 802.15.4t™-2017, IEEE Std 802.15.4v™-2017, IEEE Std 802.15.4s™-2018, and IEEE Std 802.15.4-2015/Cor. 1-2018.)

NOTE—The editing instructions contained in this amendment define how to merge the material contained therein into the existing base standard and its amendments to form the comprehensive standard.

The editing instructions are shown in ***bold italic***. Four editing instructions are used: change, delete, insert, and replace. ***Change*** is used to make corrections in existing text or tables. The editing instruction specifies the location of the change and describes what is being changed by using ~~strike~~ (to remove old material) and underscore (to add new material). ***Delete*** removes existing material. ***Insert*** adds new material without disturbing the existing material. Insertions may require renumbering. If so, renumbering instructions are given in the editing instruction. ***Replace*** is used to make changes in figures or equations by removing the existing figure or equation and replacing it with a new one. Editing instructions, change markings, and this NOTE will not be carried over into future editions because the changes will be incorporated into the base standard.¹

¹ Notes in text, tables, and figures are given for information only and do not contain requirements needed to implement the standard.

7. MAC frame formats

7.4 IEs

7.4.4 Nested IE

7.4.4.10 SUN Device Capabilities IE

Change the 15th paragraph in 7.4.4.10 as indicated:

The PHY Modes Supported field is a bitmap indicating which PHY modes are supported for the PHY Type. The PHY modes for each possible PHY Type are defined in Table 7-21, Table 7-22, [Table 7-22a](#), Table 7-23, Table 7-24, Table 7-25, and Table 7-26. A bit set to one in bit b_n of the PHY Mode ID bitmap indicates that the PHY Mode with ID n in the table of PHY Modes corresponding to the PHY Type is supported; otherwise, it is not supported.

Change Table 7-20 as indicated:

Table 7-20—Modulation scheme encoding

PHY type	Modulation scheme
0	FSK-A
1	FSK-B
2	O-QPSK-A
3	O-QPSK-B
4	O-QPSK-C
5	OFDM Option 1
6	OFDM Option 2
7	OFDM Option 3
8	OFDM Option 4
<u>9</u>	FSK-C
9 <u>10</u> –15	Reserved

Insert the following new paragraph and Table 7-22a after Table 7-22 in 7.4.4.10:

The FSK-C PHY mode encodings are defined in Table 7-22a.

Table 7-22a—FSK-C PHY mode encoding

PHY Mode ID	Narrowband FSK PHY mode
0	10 kb/s; 2-FSK; mod index = 1.0; channel spacing = 50 kHz
1	20 kb/s; 2-FSK; mod index = 1.0; channel spacing = 100 kHz
2–10	Reserved

10. General PHY requirements

10.1 General requirements and definitions

10.1.2 Channel assignments

10.1.2.8 Channel numbering for SUN and TVWS PHYs

Change the following rows in Table 10-10 as indicated:

Table 10-10—Channel numbering for SUN PHYs

Frequency band (MHz)	Modulation	ChanSpacing (MHz)	TotalNumChan	ChanCenterFreq ₀ (MHz)
...				
470–510	SUN FSK operating mode #1, #2, & #3	0.2	199	470.2
	SUN FSK operating mode #1a	0.05	793	470.2
	SUN FSK operating mode #1b	0.1	397	470.2
	SUN OFDM Option 4	0.2	199	470.2
	SUN O-QPSK	0.2	199	470.2
779–787	SUN FSK operating mode #1	0.2	39	779.2
	SUN FSK operating mode #2 & #3	0.4	19	779.4
	SUN FSK operating mode #1a	0.05	153	779.2
	SUN FSK operating mode #1b	0.1	77	779.2
	OFDM Option 4	0.2	39	779.2
	OFDM Option 3	0.4	19	779.4
	OFDM Option 2	0.8	9	779.8
	OFDM Option 1	1.2	6	780.2
	SUN O-QPSK	0.2	39	779.2
	O-QPSK	2	4	780
863–870	SUN FSK operating mode #1 & #1b	0.1	69	863.1
	SUN FSK operating mode #2 & #3	0.2	35	863.1
	SUN FSK operating mode #1a	0.05	137	863.1
	SUN OFDM Option 4	0.2	35	863.1
	SUN O-QPSK	0.2	35	863.1
865–867	SUN FSK operating mode #1 & #1b	0.1	19	865.1
	SUN FSK operating mode #2 & #3	0.2	10	865.1
	SUN FSK operating mode #1a	0.05	37	865.1
	OFDM Option 4	0.2	10	865.1
	O-QPSK	0.2	10	865.1

Table 10-10—Channel numbering for SUN PHYs (continued)

Frequency band (MHz)	Modulation	ChanSpacing (MHz)	TotalNumChan	ChanCenterFreq ₀ (MHz)
866–869	SUN FSK operating mode #1 & #1b	0.1	29 (channels 30–58 are used)	863.1 (first frequency used is 866.1)
	SUN FSK operating mode #2 & #3	0.2	15 (channels 15–29 are used)	863.1 (first frequency used is 866.1)
	SUN FSK operating mode #4 & #5	0.4	7 (channels 8–14 are used)	863.2 (first frequency used is 866.4)
	SUN FSK operating mode #1a	0.05	57 (channels 60–116 are used)	863.1 (first frequency used is 866.1)
	SUN OFDM Option 4	0.2	15 (channels 15–29 are used)	863.1 (first frequency used is 866.1)
	SUN OFDM Option 3	0.4	7 (channels 8–14 are used)	863.2 (first frequency used is 866.4)
	SUN O-QPSK	0.2	15 (channels 15–29 are used)	863.1 (first frequency used is 866.1)
...				
870–876	SUN FSK operating mode #1 & #1b	0.1	59	870.1
	SUN FSK operating mode #2 & #3	0.2	30	870.1
	SUN FSK operating mode #1a	0.05	117	870.1
	SUN OFDM Option 4	0.2	30	870.1
	SUN O-QPSK	0.2	30	870.1
...				
902–928	SUN FSK operating mode #1	0.2	129	902.2
	SUN FSK operating mode #2 & #3	0.4	64	902.4
	SUN FSK operating mode #1a	0.05	513	902.2
	SUN FSK operating mode #1b	0.1	257	902.2
	OFDM Option 4	0.2	129	902.2
	OFDM Option 3	0.4	64	902.4
	OFDM Option 2	0.8	31	902.8
	OFDM Option 1	1.2	20	903.2
	SUN O-QPSK	0.2	129	902.2
	O-QPSK	2	12	904
902–928 (alternate)	SUN FSK operating mode #1, #2, & #3	0.2	129	902.2
	SUN FSK operating mode #4 & #5	0.4	64	902.4
	SUN FSK operating mode #1a	0.05	513	902.2
	SUN FSK operating mode #1b	0.1	257	902.2
	SUN OFDM Option 4	0.2	129	902.2
	SUN OFDM Option 3	0.4	64	902.4
	SUN OFDM Option 2	0.8	31	902.8
	SUN OFDM Option 1	1.2	20	903.2
	SUN O-QPSK	0.2	129	902.2
	SUN O-QPSK	2	12	904

Table 10-10—Channel numbering for SUN PHYs (continued)

Frequency band (MHz)	Modulation	ChanSpacing (MHz)	TotalNumChan	ChanCenterFreq ₀ (MHz)
902–907.5 & 915–928	SUN FSK operating mode #1, #2, & #3	0.2	91 (channels 0–26 & 65–128 are used)	902.2
	SUN FSK operating mode #4 & #5	0.4	45 (channels 0–12 & 32–63 are used)	902.4
	SUN FSK operating mode #1a	0.05	358 (channels 0–104 & 260–512 are used)	902.2
	SUN FSK operating mode #1b	0.1	180 (channels 0–52 & 130–256 are used)	902.2
	SUN OFDM Option 4	0.2	91 (channels 0–26 & 65–128 are used)	902.2
	SUN OFDM Option 3	0.4	45 (channels 0–12 & 32–63 are used)	902.4
	SUN OFDM Option 2	0.8	21 (channels 0–5 & 16–30 are used)	902.8
	SUN OFDM Option 1	1.2	13 (channels 0–3 & 11–19 are used)	903.2
	SUN O-QPSK	0.2	91 (channels 0–26 & 65–128 are used)	902.2
	SUN O-QPSK	2	8 (channels 0, 1 & 6–11 are used)	904
915–928	SUN FSK operating mode #1, #2, & #3	0.2	64 (channels 65–128 are used)	902.2 (first frequency used is 915.2)
	SUN FSK operating mode #4 & #5	0.4	32 (channels 32–63 are used)	902.4 (first frequency used is 915.2)
	SUN FSK operating mode #1a	0.05	253 (channels 260–512 are used)	902.2 (first frequency used is 915.2)
	SUN FSK operating mode #1b	0.1	127 (channels 130–256 are used)	902.2 (first frequency used is 915.2)
	SUN OFDM Option 4	0.2	64 (channels 65–128 are used)	902.2 (first frequency used is 915.2)
	SUN OFDM Option 3	0.4	32 (channels 32–63 are used)	902.4 (first frequency used is 915.2)
	SUN OFDM Option 2	0.8	15 (channels 16–30 are used)	902.8 (first frequency used is 915.6)
	SUN OFDM Option 1	1.2	9 (channels 11–19 are used)	903.2 (first frequency used is 916.4)
	SUN O-QPSK	0.2	64 (channels 65–128 are used)	902.2 (first frequency used is 915.2)
	SUN O-QPSK	2	6 (channels 6–11 are used)	904 (first frequency used is 916)

Table 10-10—Channel numbering for SUN PHYs (continued)

Frequency band (MHz)	Modulation	ChanSpacing (MHz)	TotalNumChan	ChanCenterFreq ₀ (MHz)
915–921	SUN FSK operating mode #1, #2, & #3	0.2	29 (channels 65–93 are used)	902.2 (first frequency used is 915.2)
	SUN FSK operating mode #4 & #5	0.4	15 (channels 32–46 are used)	902.4 (first frequency used is 915.2)
	SUN FSK operating mode #1a	0.05	133 (channels 260–372 are used)	902.2 (first frequency used is 915.2)
	SUN FSK operating mode #1b	0.1	57 (channels 130–186 are used)	902.2 (first frequency used is 915.2)
	SUN OFDM Option 4	0.2	29 (channels 65–93 are used)	902.2 (first frequency used is 915.2)
	SUN OFDM Option 3	0.4	15 (channels 32–46 are used)	902.4 (first frequency used is 915.2)
	SUN O-QPSK	0.2	29 (channels 65–93 are used)	902.2 (first frequency used is 915.2)
915–918	SUN FSK operating mode #1, #2, & #3	0.2	14 (channels 65–78 are used)	902.2 (first frequency used is 915.2)
	SUN FSK operating mode #4 & #5	0.4	7 (channels 32–38 are used)	902.4 (first frequency used is 915.2)
	SUN FSK operating mode #1a	0.05	53 (channels 260–312 are used)	902.2 (first frequency used is 915.2)
	SUN FSK operating mode #1b	0.1	27 (channels 130–156 are used)	902.2 (first frequency used is 915.2)
	SUN OFDM Option 4	0.2	14 (channels 65–78 are used)	902.2 (first frequency used is 915.2)
	SUN OFDM Option 3	0.4	7 (channels 32–38 are used)	902.4 (first frequency used is 915.2)
	SUN OFDM Option 2	0.8	3 (channels 16–18 are used)	902.8 (first frequency used is 915.6)
	SUN OFDM Option 1	1.2	1 (channel 11 is used)	903.2 (only frequency used is 916.4)
	SUN O-QPSK	0.2	14 (channels 65–78 are used)	902.2 (first frequency used is 915.2)

Table 10-10—Channel numbering for SUN PHYs (continued)

Frequency band (MHz)	Modulation	ChanSpacing (MHz)	TotalNumChan	ChanCenterFreq ₀ (MHz)
917–923.5	OFDM Option 4	0.2	32	917.1
	OFDM Option 3	0.4	16	917.3
	OFDM Option 2	0.8	8	917.5
	OFDM Option 1	1.2	5	917.9
	SUN FSK operating mode #1	0.2	32	917.1
	SUN FSK operating mode #2 & #3	0.4	16	917.3
	SUN FSK operating mode #1a	0.05	125	917.1
	SUN FSK operating mode #1b	0.1	63	917.1
	SUN O-QPSK	0.2	32	917.1
	O-QPSK	2	3	918.1
919–923	SUN FSK operating mode #1, #2, & #3	0.2	19 (channels 85–103 are used)	902.2 (first frequency used is 919.2)
	SUN FSK operating mode #4 & #5	0.4	10 (channels 42–51 are used)	902.4 (first frequency used is 919.2)
	SUN FSK operating mode #1a	0.05	73 (channels 340–412 are used)	902.2 (first frequency used is 919.2)
	SUN FSK operating mode #1b	0.1	37 (channels 170–206 are used)	902.2 (first frequency used is 919.2)
	SUN OFDM Option 4	0.2	19 (channels 85–103 are used)	902.2 (first frequency used is 919.2)
	SUN OFDM Option 3	0.4	10 (channels 42–51 are used)	902.4 (first frequency used is 919.2)
	SUN OFDM Option 2	0.8	4 (channels 21–24 are used)	902.8 (first frequency used is 919.6)
	SUN OFDM Option 1	1.2	3 (channels 14–16 are used)	903.2 (first frequency used is 920)
	SUN O-QPSK	0.2	19 (channels 85–103 are used)	902.2 (first frequency used is 919.2)

Table 10-10—Channel numbering for SUN PHYs (continued)

Frequency band (MHz)	Modulation	ChanSpacing (MHz)	TotalNumChan	ChanCenterFreq ₀ (MHz)
920.5–924.5	SUN FSK operating mode #1, #2, & #3	0.2	20 (channels 92–111 are used)	902.2 (first frequency used is 920.6)
	SUN FSK operating mode #1a	0.05	77 (channels 368–444 are used)	902.2 (first frequency used is 920.6)
	SUN FSK operating mode #1b	0.1	39 (channels 169–207 are used)	902.2 (first frequency used is 920.6)
	SUN OFDM Option 4	0.2	20 (channels 92–111 are used)	902.2 (first frequency used is 920.6)
	SUN O-QPSK	0.2	20 (channels 92–111 are used)	902.2 (first frequency used is 920.6)
920–925	SUN FSK operating mode #1, #2, & #3	0.2	24 (channels 90–113 are used)	902.2 (first frequency used is 920.2)
	SUN FSK operating mode #4 & #5	0.4	12 (channels 45–56 are used)	902.4 (first frequency used is 920.2)
	SUN FSK operating mode #1a	0.05	93 (channels 360–452 are used)	902.2 (first frequency used is 920.2)
	SUN FSK operating mode #1b	0.1	47 (channels 180–226 are used)	902.2 (first frequency used is 920.2)
	SUN OFDM Option 4	0.2	24 (channels 90–113 are used)	902.2 (first frequency used is 920.2)
	SUN OFDM Option 3	0.4	12 (channels 45–56 are used)	902.4 (first frequency used is 920.2)
	SUN OFDM Option 2	0.8	6 (channels 22–27 are used)	902.8 (first frequency used is 920.4)
	SUN OFDM Option 1	1.2	3 (channels 15–17 are used)	903.2 (first frequency used is 921.2)
	SUN O-QPSK	0.2	24 (channels 90–113 are used)	902.2 (first frequency used is 920.2)

Table 10-10—Channel numbering for SUN PHYs (continued)

Frequency band (MHz)	Modulation	ChanSpacing (MHz)	TotalNumChan	ChanCenterFreq ₀ (MHz)
920–928	SUN FSK operating mode #1	0.2	38	920.6
	SUN FSK operating mode #2	0.4	18	920.9
	SUN FSK operating mode #3 & #4	0.6	12	920.8
	SUN FSK operating mode #1a	0.05	149	920.6
	SUN FSK operating mode #1b	0.1	75	920.6
	OFDM Option 4	0.2	39	920.2
	OFDM Option 3	0.4	19	920.4
	OFDM Option 2	0.8	9	920.8
	OFDM Option 1	1.2	6	921.2
	O-QPSK	0.2	38	920.6
	...			

20. SUN FSK PHY

20.1 Introduction

Change the second paragraph of 20.1 as indicated:

For the SUN FSK PHY, the symbol period used for MAC and PHY timing parameters, shown in Table 20-1, shall be the symbol period of operating mode #1 ([specified in Table 20-6 and Table 20-7](#)) [and operating mode #1a \(specified in Table 20-7a\)](#).

20.3 Modulation and coding for SUN FSK

Insert the following new paragraph and Table 20-7a after Table 20-7 in 20.3:

Frequency bands 470 MHz, 780 MHz, 863 MHz, 866 MHz, 867 MHz, 870 MHz, 915 MHz, 915 MHz-a, 915 MHz-b, 915 MHz-c, 915 MHz-d, 915 MHz-e, 917 MHz, 919 MHz, 920 MHz, 920 MHz-a, and 920 MHz-b may additionally support operating modes #1a and #1b as specified in Table 20-7a.

Table 20-7a—Additional SUN FSK modulation and channel parameters

Parameter	Operating mode #1a	Operating mode #1b
Data rate (kb/s)	10	20
Modulation	2-FSK	2-FSK
Modulation index	1.0	1.0
Channel spacing (kHz)	50	100

20.6 SUN FSK PHY RF requirements

20.6.6 Transmit spectral mask

Change the fifth paragraph (from IEEE Std 802.15.4v-2017) of 20.6.6 as indicated:

Otherwise, for all other operating modes specified in Table 20-6, ~~and~~ Table 20-7, and Table 20-7a, the ~~±~~ offset frequencies M_1 and M_2 and the integrated bandwidth shall be defined as follows:

21. SUN OFDM PHY

21.3 Data rates for SUN OFDM

Change Table 21-9 as indicated:

Table 21-9—Data rates for SUN OFDM PHY

Parameter	OFDM Option 1	OFDM Option 2	OFDM Option 3	OFDM Option 4
Nominal bandwidth (kHz)	1094	552	281	156
Channel spacing (kHz)	1200	800	400	200
DFT size	128	64	32	16
Active tones	104	52	26	14
# Pilot tones	8	4	2	2
# Data tones	96	48	24	12
MCS0 (kb/s) (BPSK rate 1/2 with 4x frequency repetition)	100	50	<u>25</u>	<u>12.5</u>
MCS1 (kb/s) (BPSK rate 1/2 with 2x frequency repetition)	200	100	50	<u>25</u>
MCS2 (kb/s) (QPSK rate 1/2 with 2x frequency repetition)	400	200	100	50
MCS3 (kb/s) (QPSK rate 1/2)	800	400	200	100
MCS4 (kb/s) (QPSK rate 3/4)	<u>1200</u>	600	300	150
MCS5 (kb/s) (16-QAM rate 1/2)	<u>1600</u>	800	400	200
MCS6 (kb/s) (16-QAM rate 3/4)	<u>2400</u>	<u>1200</u>	600	300

21.4 Modulation and coding for SUN OFDM

21.4.3 PIB attribute values for *phySymbolsPerOctet*

Change Table 21-11 as indicated:

Table 21-11—*phySymbolsPerOctet* values for SUN OFDM PHY

MCS level	OFDM Option			
	1	2	3	4
MCS0 (BPSK 1/2 rate coded and 4x frequency repetition)	2/3	4/3	<u>8/3</u>	<u>16/3</u>
MCS1 (BPSK 1/2 rate coded and 2x frequency repetition)	1/3	2/3	4/3	<u>8/3</u>
MCS2 (QPSK 1/2 rate coded and 2x frequency repetition)	1/6	1/3	2/3	4/3
MCS3 (QPSK 1/2 rate coded)	1/12	1/6	1/3	2/3
MCS4 (QPSK 3/4 rate coded)	<u>1/18</u>	1/9	2/9	4/9
MCS5 (16-QAM 1/2 rate coded)	<u>1/24</u>	1/12	1/6	1/3
MCS6 (16-QAM 3/4 rate coded)	<u>1/36</u>	<u>1/18</u>	1/9	2/9

21.4.5 Interleaver

Change the third and fourth paragraphs and Table 21-12 in 21.4.5 as indicated:

Devices shall support an interleaving depth of one symbol, which is associated with a value of zero for the PIB attribute *phyOfdmInterleaving*, as defined in 11.3. The values for N_{cbps} with *phyOfdmInterleaving* set to zero are shown in Table 21-12. In this case, N_{cbps} is defined as follows: 24, 48, 96, ~~or 192~~, or 384 bits for Option 1; 12, 24, 48, 96, or 192 bits for Option 2; 6, 12, 24, 48, or 96 bits for Option 3; 3, 6, 12, 24, or 48 bits for Option 4.

Table 21-12— N_{cbps} for SUN OFDM with *phyOfdmInterleaving* = 0

MCS level	OFDM Option 1	OFDM Option 2	OFDM Option 3	OFDM Option 4
MCS0	24	12	<u>6</u>	<u>3</u>
MCS1	48	24	12	<u>6</u>
MCS2	96	48	24	12
MCS3	192	96	48	24
MCS4	<u>192</u>	96	48	24
MCS5	<u>384</u>	192	96	48
MCS6	<u>384</u>	<u>192</u>	96	48

Devices may support an interleaving depth of the number of symbols equal to the frequency domain spreading factor, which is associated with a value of one for the PIB attribute *phyOfdmInterleaving*. The frequency domain spreading factor can be one, two, or four. In this case, N_{cbps} is defined as follows: 96 bits for BPSK, ~~or 192~~ bits for QPSK, or 384 bits for 16-QAM in Option 1; 48 bits for BPSK, 96 bits for QPSK, or 192 bits for 16-QAM in Option 2; 24 bits for BPSK, 48 bits for QPSK, or 96 bits for 16-QAM in Option 3; 12 bits for BPSK, 24 bits for QPSK, or 48 bits for 16-QAM in Option 4.

21.5 SUN OFDM PHY RF requirements

21.5.3 Receiver sensitivity

Change Table 21-20 as indicated:

Table 21-20—Sensitivity requirements for OFDM options and MCS levels

	Option 1	Option 2	Option 3	Option 4
MCS0 (BPSK ½ rate coded and 4x frequency repetition)	–103 dBm	–105 dBm	–108 dBm	–111 dBm
MCS1 (BPSK ½ rate coded and 2x frequency repetition)	–100 dBm	–103 dBm	–105 dBm	–108 dBm
MCS2 (QPSK ½ rate coded and 2x frequency repetition)	–97 dBm	–100 dBm	–103 dBm	–105 dBm
MCS3 (QPSK ½ rate coded)	–94 dBm	–97 dBm	–100 dBm	–103 dBm
MCS4 (QPSK ¾ rate coded)	–91 dBm	–94 dBm	–97 dBm	–100 dBm
MCS5 (16-QAM ½ rate coded)	–88 dBm	–91 dBm	–94 dBm	–97 dBm
MCS6 (16-QAM ¾ rate coded)	–85 dBm	–88 dBm	–91 dBm	–94 dBm

22. SUN O-QPSK PHY

22.3 Modulation and coding for SUN O-QPSK

22.3.2 SHR coding and spreading

Change the following rows of Table 21-2 as indicated:

Table 22-2—SHR coding and spreading parameters

Frequency band (MHz)	Chip rate (kchip/s)	BDE	Spreading mode
...			
779–787	100	yes	(32,1)₀-DSSS
	1000	yes	(64,1)-DSSS
...			
902–928	100	yes	(32,1)₀-DSSS
	1000	yes	(64,1)-DSSS
902–928(alternate)	100	yes	(32,1)₀-DSSS
	1000	yes	(64,1)-DSSS
902–907.5 & 915–928	100	yes	(32,1)₀-DSSS
	1000	yes	(64,1)-DSSS
915–928	100	yes	(32,1)₀-DSSS
	1000	yes	(64,1)-DSSS
...			
917–923.5	100	yes	(32,1)₀-DSSS
	1000	yes	(64,1)-DSSS
...			

22.3.3 PHR coding and spreading

Change the following rows of Table 22-3 as indicated:

Table 22-3—PHR coding and spreading parameters

Frequency band (MHz)	Chip rate (kchip/s)	BDE	rate ½ FEC + interleaver	Spreading mode
...				
779–787	<u>100</u>	<u>yes</u>	<u>yes</u>	<u>(8,1)_{0/1}-DSSS</u>
	1000	yes	yes	(16,1) _{0/1} -DSSS
...				
902–928	<u>100</u>	<u>yes</u>	<u>yes</u>	<u>(8,1)_{0/1}-DSSS</u>
	1000	yes	yes	(16,1) _{0/1} -DSSS
902–928(alternate)	<u>100</u>	<u>yes</u>	<u>yes</u>	<u>(8,1)_{0/1}-DSSS</u>
	1000	yes	yes	(16,1) _{0/1} -DSSS
902–907.5 & 915–928	<u>100</u>	<u>yes</u>	<u>yes</u>	<u>(8,1)_{0/1}-DSSS</u>
	1000	yes	yes	(16,1) _{0/1} -DSSS
915–928	<u>100</u>	<u>yes</u>	<u>yes</u>	<u>(8,1)_{0/1}-DSSS</u>
	1000	yes	yes	(16,1) _{0/1} -DSSS
...				
917–923.5	<u>100</u>	<u>yes</u>	<u>yes</u>	<u>(8,1)_{0/1}-DSSS</u>
	1000	yes	yes	(16,1) _{0/1} -DSSS
...				

22.3.4 PSDU coding and spreading for DSSS

Change the following rows of Table 22-4 as indicated:

Table 22-4—PSDU parameters for spreading mode DSSS

Frequency band (MHz)	Chip rate (kchip/s)	Rate mode	BDE	Spreading mode	rate ½ FEC + interleaver	Data rate (kb/s)
...						
779–787	<u>100</u>	<u>0</u>	<u>yes</u>	<u>(8,1)_{0/1}-DSSS</u>	<u>yes</u>	<u>6.25</u>
		<u>1</u>	<u>yes</u>	<u>(4,1)-DSSS</u>	<u>yes</u>	<u>12.5</u>
		<u>2</u>	<u>yes</u>	<u>(2,1)-DSSS</u>	<u>yes</u>	<u>25</u>
		<u>3</u>	<u>no</u>	<u>none</u>	<u>yes</u>	<u>50</u>
	1000	0	yes	(16,1) _{0/1} -DSSS	yes	31.25
		1	no	(16,4)-DSSS	yes	125
		2	no	(8,4)-DSSS	yes	250
		3	no	none	yes	500
...						

Table 22-4—PSDU parameters for spreading mode DSSS (continued)

Frequency band (MHz)	Chip rate (kchip/s)	Rate mode	BDE	Spreading mode	rate ½ FEC + interleaver	Data rate (kb/s)
902–928	100	0	yes	(8,1)0/1-DSSS	yes	6.25
		1	yes	(4,1)-DSSS	yes	12.5
		2	yes	(2,1)-DSSS	yes	25
		3	no	none	yes	50
	1000	0	yes	(16,1) _{0/1} -DSSS	yes	31.25
		1	no	(16,4)-DSSS	yes	125
		2	no	(8,4)-DSSS	yes	250
		3	no	none	yes	500
902–928 (alternate)	100	0	yes	(8,1)_{0/1}-DSSS	yes	6.25
		1	yes	(4,1)-DSSS	yes	12.5
		2	yes	(2,1)-DSSS	yes	25
		3	no	none	yes	50
	1000	0	yes	(16,1) _{0/1} -DSSS	yes	31.25
		1	no	(16,4)-DSSS	yes	125
		2	no	(8,4)-DSSS	yes	250
		3	no	none	yes	500
902–907.5 & 915–928	100	0	yes	(8,1)_{0/1}-DSSS	yes	6.25
		1	yes	(4,1)-DSSS	yes	12.5
		2	yes	(2,1)-DSSS	yes	25
		3	no	none	yes	50
	1000	0	yes	(16,1) _{0/1} -DSSS	yes	31.25
		1	no	(16,4)-DSSS	yes	125
		2	no	(8,4)-DSSS	yes	250
		3	no	none	yes	500
915–928	100	0	yes	(8,1)_{0/1}-DSSS	yes	6.25
		1	yes	(4,1)-DSSS	yes	12.5
		2	yes	(2,1)-DSSS	yes	25
		3	no	none	yes	50
	1000	0	yes	(16,1) _{0/1} -DSSS	yes	31.25
		1	no	(16,4)-DSSS	yes	125
		2	no	(8,4)-DSSS	yes	250
		3	no	none	yes	500
...						
917–923.5	100	0	yes	(8,1)_{0/1}-DSSS	yes	6.25
		1	yes	(4,1)-DSSS	yes	12.5
		2	yes	(2,1)-DSSS	yes	25
		3	no	none	yes	50
	1000	0	yes	(16,1) _{0/1} -DSSS	yes	31.25
		1	no	(16,4)-DSSS	yes	125
		2	no	(8,4)-DSSS	yes	250
		3	no	none	yes	500
...						

22.3.11 Chip whitening

Change Table 22-19 as indicated:

Table 22-19—Chip whitening for DSSS

Frequency band (MHz)	Chip rate (kchip/s)	Rate mode
470–510	100	1 and 2 and 3
779–787	100	1 and 2 and 3
	1000	2 and 3
865–867	100	1 and 2 and 3
866–869	100	1 and 2 and 3
868–870	100	1 and 2 and 3
870–876	100	1 and 2 and 3
902–928	100	1 and 2 and 3
	1000	2 and 3
902–928(alternate)	100	1 and 2 and 3
	1000	2 and 3
902–907.5 & 915–928	100	1 and 2 and 3
	1000	2 and 3
915–928	100	1 and 2 and 3
	1000	2 and 3
915–921	100	1 and 2 and 3
915–918	100	1 and 2 and 3
917–923.5	100	1 and 2 and 3
	1000	2 and 3
919–923	100	1 and 2 and 3
920–928	100	1 and 2 and 3
920.5–924.5	100	1 and 2 and 3
920–925	100	1 and 2 and 3
2400–2483.5	2000	3

22.3.12 Pilot insertion

Change Table 22-20 as indicated:

Table 22-20—Pilot length, spacing and chip sequences

Frequency band (MHz)	Length N_p (# of chips)	Spacing M_p (# of chips)	Chip sequence $p = (p_0, p_1, \dots, p_{N_p-1})$
...			
779–787	32	512	1101 1110 1010 0010 0111 0000 0110 0101
	64	1024	1011 0010 0010 0101 1011 0001 1101 0000 1101 0111 0011 1101 1111 0000 0010 1010
...			
902–928	32	512	1101 1110 1010 0010 0111 0000 0110 0101
	64	1024	1011 0010 0010 0101 1011 0001 1101 0000 1101 0111 0011 1101 1111 0000 0010 1010

Table 22-20—Pilot length, spacing and chip sequences (*continued*)

Frequency band (MHz)	Length N_p (# of chips)	Spacing M_p (# of chips)	Chip sequence $p = (p_0, p_1, \dots, p_{N_p-1})$
902–928(alternate)	32	512	1101 1110 1010 0010 0111 0000 0110 0101
	64	1024	1011 0010 0010 0101 1011 0001 1101 0000 1101 0111 0011 1101 1111 0000 0010 1010
902–907.5 & 915–928	32	512	1101 1110 1010 0010 0111 0000 0110 0101
	64	1024	1011 0010 0010 0101 1011 0001 1101 0000 1101 0111 0011 1101 1111 0000 0010 1010
915–928	32	512	1101 1110 1010 0010 0111 0000 0110 0101
	64	1024	1011 0010 0010 0101 1011 0001 1101 0000 1101 0111 0011 1101 1111 0000 0010 1010
...			
917–923.5	32	512	1101 1110 1010 0010 0111 0000 0110 0101
	64	1024	1011 0010 0010 0101 1011 0001 1101 0000 1101 0111 0011 1101 1111 0000 0010 1010
...			

22.5 SUN O-QPSK PHY RF requirements

22.5.3 Receiver sensitivity

Change Table 22-21 as indicated:

Table 22-21—Required receiver sensitivity for spreading mode DSSS [dBm]

Frequency band (MHz)	Chip rate (kchip/s)	Rate mode			
		0	1	2	3
470–510	100	–110	–105	–100	–95
779–787	100	–110	–105	–100	–95
	1000	–105	–100	–95	–90
865–867	100	–110	–105	–100	–95
866–869	100	–110	–105	–100	–95
868–870	100	–110	–105	–100	–95
870–876	100	–110	–105	–100	–95
902–928	100	–110	–105	–100	–95
	1000	–105	–100	–95	–90
902–928(alternate)	100	–110	–105	–100	–95
	1000	–105	–100	–95	–90
902–907.5 & 915–928	100	–110	–105	–100	–95
	1000	–105	–100	–95	–90
915–928	100	–110	–105	–100	–95
	1000	–105	–100	–95	–90
915–921	100	–110	–105	–100	–95
915–918	100	–110	–105	–100	–95

Table 22-21—Required receiver sensitivity for spreading mode DSSS [dBm] (continued)

Frequency band (MHz)	Chip rate (kchip/s)	Rate mode			
		0	1	2	3
917–923.5	100	–110	–105	–100	–95
	1000	–105	–100	–95	–90
919–923	100	–110	–105	–100	–95
920–928	100	–110	–105	–100	–95
920.5–924.5	100	–110	–105	–100	–95
920–925	100	–110	–105	–100	–95
2400–2483.5	2000	–105	–100	–95	–90

22.5.4 Adjacent channel rejection

Change Table 22-23 as indicated:

Table 22-23—Minimum interference-to-signal ratio (ISR) requirements depending on $|\Delta f|$

Frequency band (MHz) 470–510	Chip rate (kchip/s) 100	$ \Delta f $ (MHz)	0.4	0.8
		ISR (dB)	10	30
Frequency band (MHz) 779–787	Chip rate (kchip/s) 100	Δf (MHz)	0.4	0.8
		ISR (dB)	10	30
	Chip rate (kchip/s) 1000	$ \Delta f $ (MHz)	2.0	4.0
		ISR (dB)	10	30
Frequency band (MHz) 865–867	Chip rate (kchip/s) 100	$ \Delta f $ (MHz)	0.2	1.4
		ISR (dB)	10	30
Frequency band (MHz) 866–869	Chip rate (kchip/s) 100	$ \Delta f $ (MHz)	0.2	0.4
		ISR (dB)	10	30
Frequency band (MHz) 868–870	Chip rate (kchip/s) 100	$ \Delta f $ (MHz)	0.65	1.225
		ISR (dB)	10	30
Frequency band (MHz) 870–876	Chip rate (kchip/s) 100	$ \Delta f $ (MHz)	0.2	0.4
		ISR (dB)	10	30
Frequency band (MHz) 902–928	Chip rate (kchip/s) 100	Δf (MHz)	0.4	0.8
		ISR (dB)	10	30
	Chip rate (kchip/s) 1000	$ \Delta f $ (MHz)	2.0	4.0
		ISR (dB)	10	30
Frequency band (MHz) 902–928(alternate)	Chip rate (kchip/s) 100	Δf (MHz)	0.4	0.8
		ISR (dB)	10	30
	Chip rate (kchip/s) 1000	$ \Delta f $ (MHz)	2	4
		ISR (dB)	10	30

Table 22-23—Minimum interference-to-signal ratio (ISR) requirements depending on $|\Delta f|$ (continued)

Frequency band (MHz) 902–907.5 & 915–928	Chip rate (kchip/s) 100	 Δf (MHz)	0.4	0.8
		ISR (dB)	10	30
	Chip rate (kchip/s) 1000	 Δf (MHz)	2	4
		ISR (dB)	10	30
Frequency band (MHz) 915–928	Chip rate (kchip/s) 100	 Δf (MHz)	0.4	0.8
		ISR (dB)	10	30
	Chip rate (kchip/s) 1000	 Δf (MHz)	2	4
		ISR (dB)	10	30
Frequency band (MHz) 915–921	Chip rate (kchip/s) 100	 Δf (MHz)	0.2	0.4
		ISR (dB)	10	30
Frequency band (MHz) 915–918	Chip rate (kchip/s) 100	 Δf (MHz)	0.2	0.4
		ISR (dB)	10	30
Frequency band (MHz) 917–923.5	Chip rate (kchip/s) 100	 Δf (MHz)	0.4	0.8
		ISR (dB)	10	30
Frequency band (MHz) 919–923	Chip rate (kchip/s) 100	 Δf (MHz)	0.2	0.4
		ISR (dB)	10	30
Frequency band (MHz) 920–928	Chip rate (kchip/s) 100	 Δf (MHz)	0.2	0.4
		ISR (dB)	10	30
Frequency band (MHz) 920.5–924.5	Chip rate (kchip/s) 100	 Δf (MHz)	0.2	0.4
		ISR (dB)	10	30
Frequency band (MHz) 920–925	Chip rate (kchip/s) 100	 Δf (MHz)	0.2	0.4
		ISR (dB)	10	30
Frequency band (MHz) 2400–2483.5	Chip rate (kchip/s) 2000	 Δf (MHz)	5.0	10.0
		ISR (dB)	10	30

22.5.13 CCA

Change Table 22-24 as indicated:

Table 22-24—CCA duration for SUN O-QPSK PHY

Frequency band (MHz)	<u>Chip rate (kchip/s)</u>	<i>aCcaTime</i> (# of symbols)
470–510	<u>100</u>	4
779–787	<u>100</u>	<u>4</u>
	<u>1000</u>	8
865–867	<u>100</u>	4
866–869	<u>100</u>	4
868–870	<u>100</u>	4
870–876	<u>100</u>	4
902–928	<u>100</u>	<u>4</u>
	<u>1000</u>	8
902–928(alternate)	<u>100</u>	<u>4</u>
	<u>1000</u>	8
902–907.5 & 915–928	<u>100</u>	<u>4</u>
	<u>1000</u>	8
915–928	<u>100</u>	<u>4</u>
	<u>1000</u>	8
915–921	<u>100</u>	4
915–918	<u>100</u>	4
917–923.5	<u>100</u>	<u>4</u>
	<u>1000</u>	8
919–923	<u>100</u>	4
920.5–924.5	<u>100</u>	4
920–925	<u>100</u>	4
2400–2483.5	<u>2000</u>	8

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